



**Assembly notes:**

1. R101 and R102 are reworked parts.
2. PMP9624Rev C circuit to be built on PMP9624Rev A PCB.

PCB Number: PMP9624  
PCB Rev: A

PCB  
LOGO  
Texas Instruments

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Number: PMP9624	Rev: C	Designed for: Public Release	Mod. Date: 6/1/2015
SVN Rev. Version control disabled		Project Title: -18Vin to -50Vin to -3.3Vout/2A Negative Buck	
Assembly Variant: 001		Sheet Title:	
Drawn By: S Yu	File: PMP9624_01.SchDoc	Sheet: 1 of 1	Size: B
Engineer: S Yu	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		



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